Wicrosemi POWER PRODUCTS GROUP

1200V, 70A, $\rm V_{ce(on)}\,$ = 2.5V Typical

Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT[®] is a new generation of high voltage power IGBTs. Using Non-Punch-Through Technology, the Ultra Fast NPT-IGBT[®] offers superior ruggedness and ultrafast switching speed.

Features

- Low Saturation Voltage
- Low Tail Current
- RoHS Compliant *M*

- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

MAXIMUM RATINGS

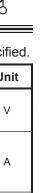
All Ratings: $T_{C} = 25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Ratings	Unit
V _{ces}	Collector Emitter Voltage	1200	V
V _{GE}	Gate-Emitter Voltage	±30	v
I _{C1}	Continuous Collector Current @ T _c = 25°C	112	
I _{C2}	Continuous Collector Current @ T _c = 86°C	70	А
I _{CM}	Pulsed Collector Current ①	280	
SCWT	Short Circuit Withstand Time: V_{CE} = 600V, V_{GE} = 15V, T_{C} =125°C	10	μs
P _D	Total Power Dissipation @ T_c = 25°C	543	W
T_,T _{stg}	Operating and Storage Junction Temperature Range	-55 to 150	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Мах	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage ($V_{GE} = 0V$, $I_{C} = 1.0$ mA)	1200			
V _{GE(TH)}	Gate Threshold Voltage ($V_{CE} = V_{GE}$, $I_{C} = 2.5$ mA, $T_{j} = 25^{\circ}$ C)	3.5	5.0	6.5	
V _{CE(ON)}	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 70A, T_{j} = 25°C)		2.5	3.2	Volts
	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 70A, T_{j} = 125°C)		3.3		
	Collector-Emitter On Voltage (V_{GE} = 15V, I _c = 140A, T _j = 25°C)		3.5		
I _{ces}	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 25°C) ⁽²⁾		10	1000	μA
	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 125°C) ⁽²⁾		100		
I _{GES}	Gate-Emitter Leakage Current (V _{GE} = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.





DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
C _{ies}	Input Capacitance	Capacitance		7260		
C _{oes}	Output Capacitance	$V_{ge} = 0V, V_{ce} = 25V$		643		pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz		199		
V _{GEP}	Gate to Emitter Plateau Voltage	O sta Ottama		7.5		V
Q _q 3	Total Gate Charge	- Gate Charge		412	544	
Q _{ge}	Gate-Emitter Charge	$ V_{GE} = 15V$		48	62	
Q _{gc}	Gate- Collector Charge	$V_{cE} = 600V$ $I_{c} = 70A$		204	275	nC
t _{d(on)}	Turn-On Delay Time	Inductive Switching (25°C)	1	33		
t,	Current Rise Time	V _{cc} = 600V		48		
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		278		ns
t _r	Current Fall Time	I _c = 70A		64		
E _{on2} 5	Turn-On Switching Energy	$R_{g} = 4.3 \ \Omega^{(4)}$		3816	5720	1
E _{off}	Turn-Off Switching Energy	T _J = +25°C		2582	3870	μJ
t _{d(on)}	Turn-On Delay Time	Inductive Switching (125°C)	1	33		
t,	Current Rise Time	V _{cc} = 600V		48		ns
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		320		
t _r	Current Fall Time	I _c = 70A		74		
E _{on2} 5	Turn-On Switching Energy	$R_{g} = 4.3 \ \Omega^{(4)}$		5651	8475	1
E _{off}	Turn-Off Switching Energy	T _J = +125°C		3323	4980	μJ

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	Min	Тур	Мах	Unit
R _{ejc}	Junction to Case	-	-	0.23	°C/W
W _T	Package Weight	-	1.03	-	oz
Torque	Terminals and Mounting Screws.	-	-	10	in∙lbf
		-	-	1.1	N∙m
V _{Isolation}	RMS Voltage (50-60Hz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.)	2500	-	-	Volts

1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

2 Pulse test: Pulse Width < 380µs, duty cycle < 2%.

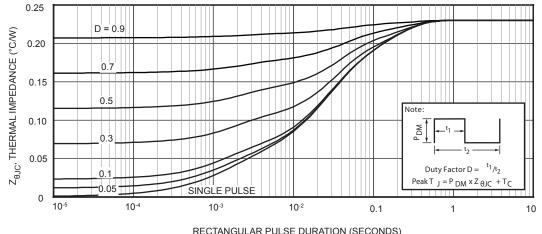
3 See Mil-Std-750 Method 3471.

4 R_g is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

5 E_{on2} is the clamped inductive turn on energy that includes a commutating diode reverse recovery current in the IGBT turn on energy loss. A combi device is used for the clamping diode.

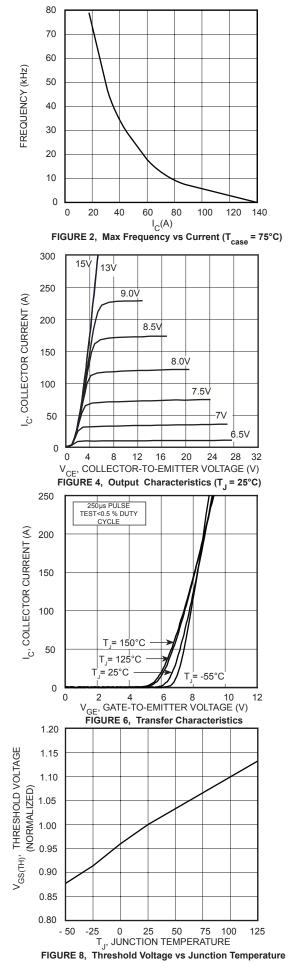
6 E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

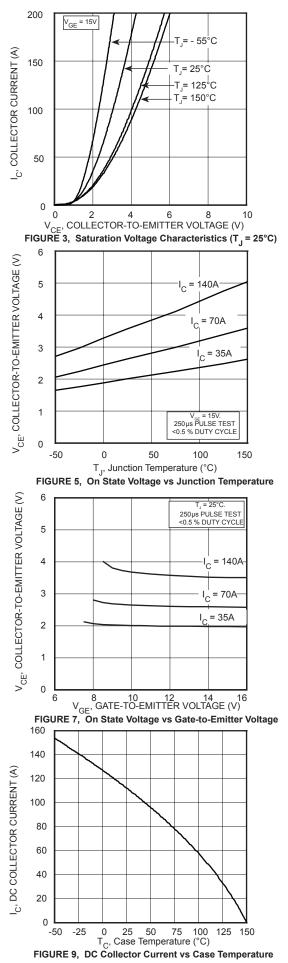
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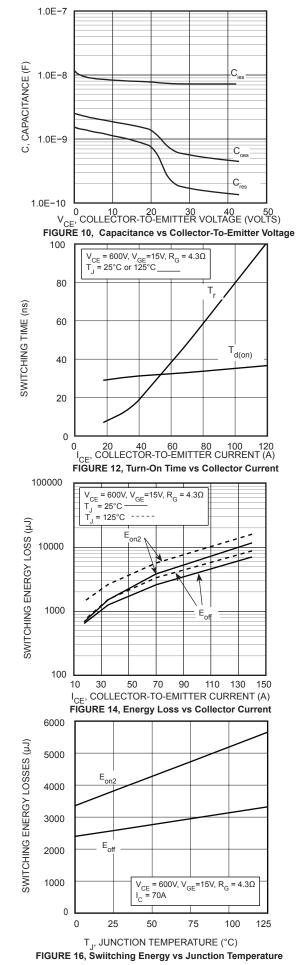


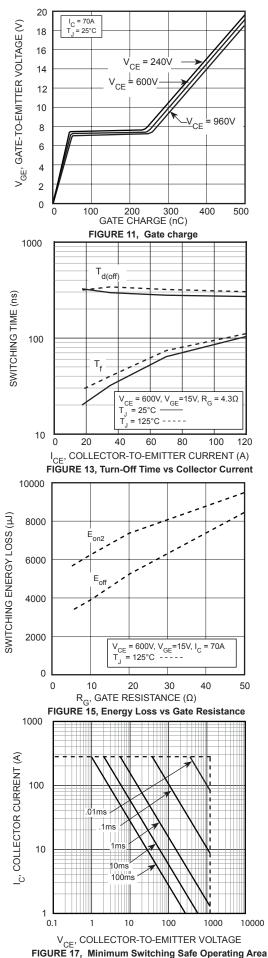
RECTANGULAR PULSE DURATION (SECONDS) Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

TYPICAL PERFORMANCE CURVES





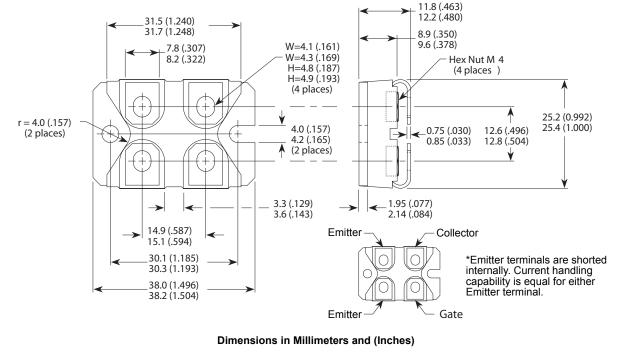




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SOT-227 (ISOTOP®) Package Outline

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